



PREMIUM THERMAL COMPOUND

Nox TG1 is a high performance thermal grease, designed for high demanding applications. A premium thermal compound with high thermal conductivity, low thermal resistance and no electrical conductivity, specially designed for its use in CPU, GPU cooling and other applications between power semiconductor components and heat sinks.

Includes plastic spatula for easy application.

This thermal paste is recommended for standard uses, as well as for overclocking purposes.



Density:	3,69 g/cm ³
Viscosity:	850 poise
Net Weight:	4 g.
Application:	CPU; GPU Cooling; Heat Sinks; PW Semiconductor Components.
Extra Features:	Plastic Palette Included for its easy application.
	Syringe format for high precision and cleanliness when being applied.